



Vishay Siliconix

# N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	$r_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ)			
30	0.057 at V <sub>GS</sub> = 10 V	5.6 <sup>a</sup>	5.5			
	$0.082 \text{ at V}_{GS} = 4.5 \text{ V}$	4.7	3.3			

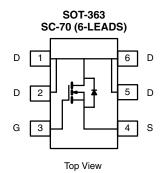
#### **FEATURES**

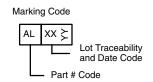
- TrenchFET® Power MOSFET
- 100 %  $\rm R_{\rm g}$  and UIS Tested



#### **APPLICATIONS**

Load Switch for Portable Devices





Ordering Information: Si1472DH-T1-E3 (Lead (Pb-free)

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	30	v	
Gate-Source Voltage		V <sub>GS</sub>	± 20		
	T <sub>C</sub> = 25 °C		5.6		
Continuous Dusin Comment /T 150 °C)	T <sub>C</sub> = 70 °C		4.5		
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a</sup>	T <sub>A</sub> = 25 °C	l <sub>D</sub>	4.2 <sup>b, c</sup>	A	
	T <sub>A</sub> = 70 °C		3.4 <sup>b, c</sup>	A	
Pulsed Drain Current		I <sub>DM</sub>	15		
Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	10		
Repetitive Avalanche Energy		E <sub>AS</sub>	5	mJ	
Operation and Operate Desire Disable Operate	T <sub>C</sub> = 25 °C		2.3		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	1.3 <sup>b, c</sup>	— A	
Maximum Power Dissipation <sup>a</sup>	T <sub>C</sub> = 25 °C		2.8		
	T <sub>C</sub> = 70 °C	ь —	1.8	14/	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	1.5 <sup>b, c</sup>	W	
	T <sub>A</sub> = 70 °C		1.0 <sup>b, c</sup>		
Operating Junction and Storage Temperature R	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 5 sec	R <sub>thJA</sub>	60	80	°C/W		
Maximum Junction-to-Foot (Drain)	Steady	R <sub>thJF</sub>	34	45			

#### Notes:

- a. Based on  $T_C$  = 25 °C. b. Surface Mounted on 1" x 1" FR4 board.
- d. Maximum under Steady State conditions is 125 °C/W.

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<b>SPECIFICATIONS</b> T <sub>J</sub> = 25 °C, unless otherwise noted								
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit		
Static								
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30			V		
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J L = 050A		25.15		>///00		
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_D = 250 \mu A$		5.6		mV/°C		
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1		3	V		
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA		
Zero Gate Voltage Drain Current	lass	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1	nA		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 85 ^{\circ}\text{C}$			10	μΑ		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} = \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	15			Α		
Drain-Source On-State Resistance <sup>a</sup>	rno:	$V_{GS} = 10 \text{ V}, I_D = 4.2 \text{ A}$	0.046 0.0		0.057			
	r <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 3.5 \text{ A}$		0.065	0.082	Ω		
Forward Transconductance	9 <sub>fs</sub>	$V_{DS} = 15 \text{ V}, I_D = 4.2 \text{ A}$		8.5		S		
Dynamic <sup>b</sup>								
Input Capacitance	C <sub>iss</sub>			380		pF		
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		75				
Reverse Transfer Capacitance	C <sub>rss</sub>			45				
Total Gate Charge	Q <sub>g</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 4.2 \text{ A}$		7	11	nC		
				3.3	5			
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 24V$ , $V_{GS} = 4.5 V$ , $I_D = 4.2 A$		1.2				
Gate-Drain Charge	$Q_gd$			1.0				
Gate Resistance	$R_{g}$	f = 1 MHz		7.1	10.6	Ω		
Turn-On Delay Time	t <sub>d(on)</sub>			7.0	11	ns		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 4.4 $\Omega$		56	84			
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong 3.4 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		18	27			
Fall Time	t <sub>f</sub>			5.5	9			
Turn-On Delay Time	t <sub>d(on)</sub>			15	23	ns		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 5.4 $\Omega$		95	143			
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong 2.8 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		12	18			
Fall Time	t <sub>f</sub>			7	11			
Drain-Source Body Diode Characteristi								
Continous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			2.3	А		
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	-			15			
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = 1.8 A		8.0	1.2	V		
Body Diode Reverse Recovery Time	t <sub>rr</sub>			12.3	19	nC		
Body Diode Reverse Recovery Charge Q <sub>rr</sub>		$I_{\rm F} = 2.3 \text{ A},  \text{di/dt} = 100  \text{A/}\mu\text{s}$		5	7.5			
Reverse Recovery Fall Time	t <sub>a</sub>	- 2.07, αναί – 10070μο		7.6		ns		
Reverse Recovery Rise Time	t <sub>b</sub>			4.7				

#### Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

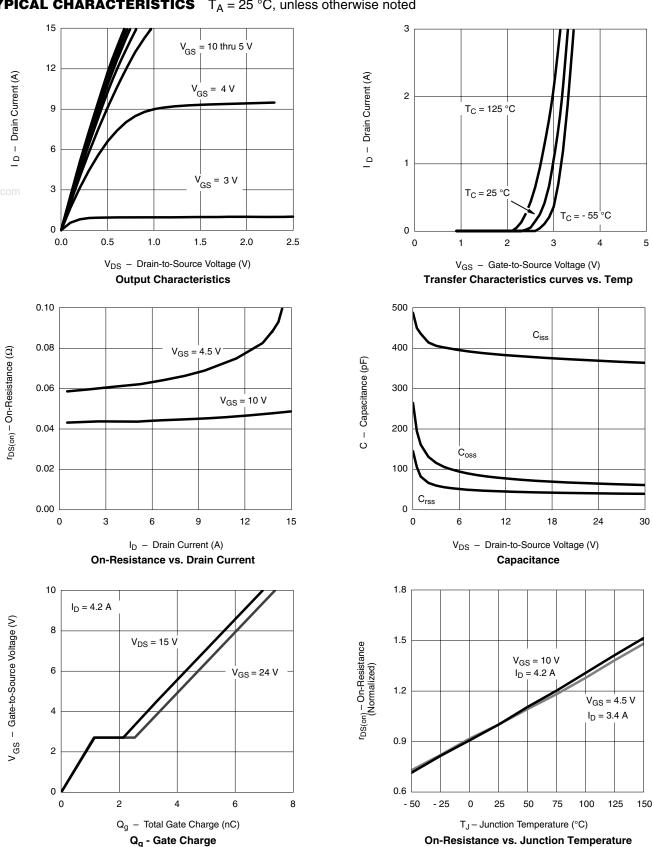
a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$ 

b. Guaranteed by design, not subject to production testing.



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### **TYPICAL CHARACTERISTICS** $T_A = 25$ °C, unless otherwise noted

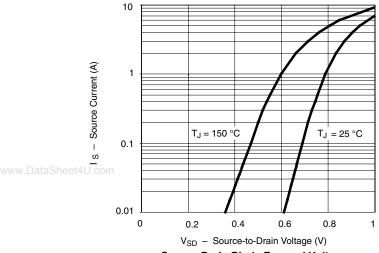


On-Resistance vs. Junction Temperature

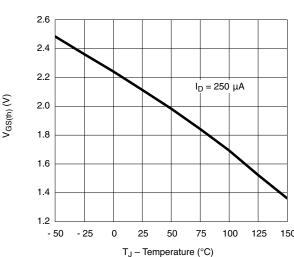
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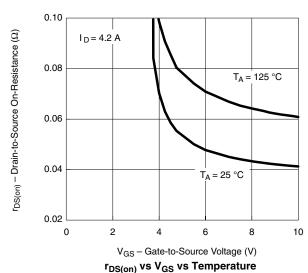
### **TYPICAL CHARACTERISTICS** $T_A = 25$ °C, unless otherwise noted







**Threshold Voltage** 



25 20 (%) 15 10

30

0

0.001

0.01

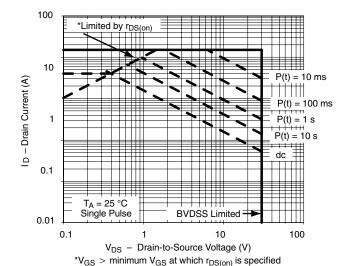
Time (sec)
Single Pulse Power

10

100

600

0.1

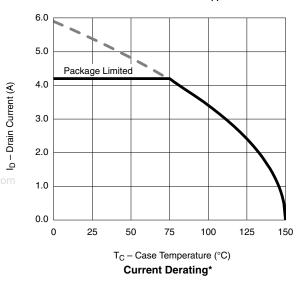


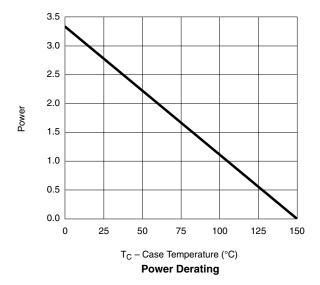
Safe Operating Area, Junction-to-Ambient



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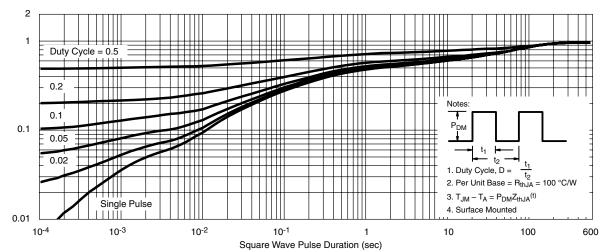
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

Normalized Effective Transient Thermal Impedance

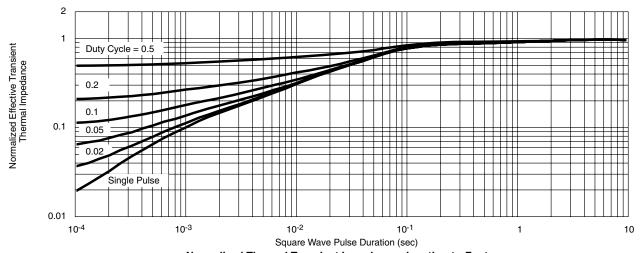
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## **TYPICAL CHARACTERISTICS** $T_A = 25 \, ^{\circ}C$ , unless otherwise noted







Normalized Thermal Transient Impedance, Junction-to-Foot

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Document Number: 91000 Revision: 18-Jul-08